

302 SERIES





FEATURES:

- Accommodates MCA (Microchannel Architecture) Daughter Boards for IBM PS/2 Systems
- .050" (1.27mm) Contact Spacing with Staggered Tail Bend Results in 4 Rows at .100" (2.54mm) Spacing
- Accepts .062" (1.57mm) Nominal Thickness P.C. Board, Accurately Positioned by Card Slot Barrier
- High Profile Insulator Body, .610" (15.49mm)
- Mounting Posts Provide Positive Location and Retention
- P.C. Tail Contact Termination
- Many other sizes available. Contact EDAC for additional items
- RoHS Compliant

Specifications:

Insulator Material	UL 94V-0 Polyphenylene Sulfide, Color: Black			
Contact Material	Copper Alloy			
Contact Plating	Gold Plating on mating area and Tin Plating on tails with Nickel underplating all over			
Current Rating	1 Amperes			
Contact Resistance	30 milliohms maximum			
Dielectric Withstand Voltage	500 VAC rms at sea level between adjacent contacts			
Insulation Resistance	1000 Megohms minimum			
Operating Temperature	-40°C to +125°C			
Insertion Force	8oz (2.22N) maximum per contact pair when tested with .062" (1.57mm) thick gauge			
Withdrawal Force	1oz (0.28N) minimum per contact pair when tested with .062" (1.57mm) thick gauge1oz (0.28N			
Example Part Number: 302-182-	520-201	Contact Code	Description & Tail Size	Tail Length "G"
Sorioo		520	P.C. Tail	.118 (3.00)
		521	P.C. Tail	.190 (4.83)
Total Number of Contacts				
Contact Code		Style		Description
Style		201	3.3V PCI With Plastic Guide Pins	
		205	3.3V PCI With Metal Board locks	
Series: 302		301	5.0V PCI W	/ith Plastic Guide Pins
112Divided in Groups of 90 & 22 Contacts132Divided in Groups of 20, 90 & 22 Contacts182Divided in Groups of 98 & 84 Contacts				
CONNECTOR M2 PIN CONNECTOR M2 PIN CONNECTOR M2 S VIEWED FROM CONNECTOR SDE				

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